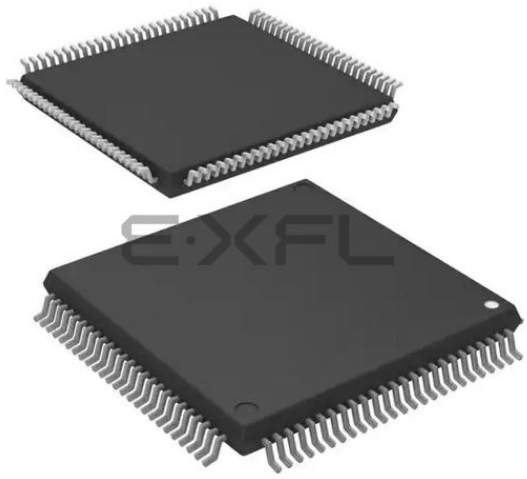
Renesas Electronics America Inc - R5F64177PFB#UB Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Last Time Buy
Core Processor	R32C/100
Core Size	16/32-Bit
Speed	50MHz
Connectivity	CANbus, EBI/EMI, I²C, IEBus, UART/USART
Peripherals	DMA, LVD, PWM, WDT
Number of I/O	84
Program Memory Size	640KB (640K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	48K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 26x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LFQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f64177pfb-ub

Table 1.2 Performance Overview for the 144-pin Package (2/2)

Unit	Function	Explanation
Timer	Timer A	16-bit timer × 5 Timer mode, event counter mode, one-shot timer mode, pulse-width modulation (PWM) mode Two-phase pulse signal processing in event counter mode (two-phase encoder input) × 3
	Timer B	16-bit timer × 6 Timer mode, event counter mode, pulse frequency measurement mode, pulse-width measurement mode
	Three-phase motor control timer	Three-phase motor control timer × 1 (timers A1, A2, A4, and B2 used) 8-bit programmable dead time timer
Serial Interface	UART0 to UART8	Asynchronous/synchronous serial interface × 9 channels • I^2C-bus (UART0 to UART6) • Special mode 2 (UART0 to UART6) • IEBus (optional (1)) (UART0 to UART6)
A/D Converter		10-bit resolution × 34 channels Sample and hold functionality integrated
D/A Converter		8-bit resolution × 2
CRC Calculator		CRC-CCITT ($X^{16} + X^{12} + X^5 + 1$)
X-Y Converter		16 bits × 16 bits
Intelligent I/O		Time measurement (input capture): 16 bits × 16 Waveform generation (output compare): 16 bits × 24 Serial interface: Variable-length synchronous serial I/O mode, IEBus mode (optional (1))
Multi-master I^2C-bus Interface		1 channel
CAN Module		1 channel CAN functionality compliant with ISO 11898-1 32 mailboxes
Flash Memory		Programming and erasure supply voltage: VCC = 3.0 to 5.5 V Minimum endurance: 1,000 program/erase cycles Security protection: ROM code protect, ID code protect Debugging: On-chip debug, on-board flash programming
Operating Frequency/Supply Voltage		64 MHz (high speed version)/VCC = 3.0 to 5.5 V 50 MHz (normal speed version)/VCC = 3.0 to 5.5 V
Operating Temperature		-20°C to 85°C (N version) -40°C to 85°C (D version) -40°C to 85°C (P version)
Current Consumption		45 mA (VCC = 5.0 V, f(CPU) = 64 MHz) 35 mA (VCC = 5.0 V, f(CPU) = 50 MHz) 8 µA (VCC = 3.3 V, f(XCIN) = 32.768 kHz, in wait mode)
Package		144-pin plastic molded LQFP (PLQP0144KA-A)

Note:
1. Contact a Renesas Electronics sales office to use the optional features.

Table 1.6 R32C/117 Group Product List for High Speed Version (2/2) As of February, 2013

Part Number	Package Code (1)	ROM Capacity (2)	RAM Capacity	Remarks
R5F6417BHNFB (P)	PLQP0100KB-A	128 Kbytes + 8 Kbytes	20 Kbytes	-20°C to 85°C (N version)
R5F6417BHDFB				-40°C to 85°C (D version)
R5F6417BHPFB				-40°C to 85°C (P version)
R5F6417AHNFB (P)	PLQP0100KB-A	256 Kbytes + 8 Kbytes		-20°C to 85°C (N version)
R5F6417AHDFB				-40°C to 85°C (D version)
R5F6417AHPFB				-40°C to 85°C (P version)
R5F64175HNFD (P)	PLQP0144KA-A	384 Kbytes + 8 Kbytes	40 Kbytes	-20°C to 85°C (N version)
R5F64175HDFD				-40°C to 85°C (D version)
R5F64175HPFD				-40°C to 85°C (P version)
R5F64175HNFB (P)	PLQP0100KB-A			-20°C to 85°C (N version)
R5F64175HDFB				-40°C to 85°C (D version)
R5F64175HPFB				-40°C to 85°C (P version)
R5F64176HNFD (P)	PLQP0144KA-A	512 Kbytes + 8 Kbytes		-20°C to 85°C (N version)
R5F64176HDFD				-40°C to 85°C (D version)
R5F64176HPFD				-40°C to 85°C (P version)
R5F64176HNFB (P)	PLQP0100KB-A			-20°C to 85°C (N version)
R5F64176HDFB				-40°C to 85°C (D version)
R5F64176HPFB				-40°C to 85°C (P version)
R5F64177HNFD (P)	PLQP0144KA-A	640 Kbytes + 8 Kbytes	48 Kbytes	-20°C to 85°C (N version)
R5F64177HDFD				-40°C to 85°C (D version)
R5F64177HPFD				-40°C to 85°C (P version)
R5F64177HNFB (P)	PLQP0100KB-A			-20°C to 85°C (N version)
R5F64177HDFB				-40°C to 85°C (D version)
R5F64177HPFB				-40°C to 85°C (P version)
R5F64178HNFD (P)	PLQP0144KA-A	768 Kbytes + 8 Kbytes	63 Kbytes	-20°C to 85°C (N version)
R5F64178HDFD				-40°C to 85°C (D version)
R5F64178HPFD				-40°C to 85°C (P version)
R5F64178HNFB (P)	PLQP0100KB-A			-20°C to 85°C (N version)
R5F64178HDFB				-40°C to 85°C (D version)
R5F64178HPFB				-40°C to 85°C (P version)
R5F64179HNFD (P)	PLQP0144KA-A	1 Mbyte + 8 Kbytes		-20°C to 85°C (N version)
R5F64179HDFD				-40°C to 85°C (D version)
R5F64179HPFD				-40°C to 85°C (P version)
R5F64179HNFB (P)	PLQP0100KB-A			-20°C to 85°C (N version)
R5F64179HDFB				-40°C to 85°C (D version)
R5F64179HPFB				-40°C to 85°C (P version)

(P): On planning phase

Notes:
1. The old package codes are as follows:
   PLQP0100KB-A: 100P6Q-A; PLQP0144KA-A: 144P6Q-A
2. “8 Kbytes” in the ROM capacity indicates the data flash memory capacity.

Table 1.8 Pin Characteristics for the 144-pin Package (2/4)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Module Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
37		P7_0		TA0OUT	TXD2/SDA2/SRXD2/ MSDA	IIO1_6/OUTC2_0/ ISTXD2/IEOUT		
38		P6_7			TXD1/SDA1/SRXD1			
39	VCC							
40		P6_6			RXD1/SCL1/STXD1			
41	VSS							
42		P6_5			CLK1			
43		P6_4			$\overline{\text{CTS1}}/\overline{\text{RTS1}}/\overline{\text{SS1}}$	OUTC2_1/ISCLK2		
44		P6_3			TXD0/SDA0/SRXD0			
45		P6_2		TB2IN	RXD0/SCL0/STXD0			
46		P6_1		TB1IN	CLK0			
47		P6_0		TB0IN	$\overline{\text{CTS0}}/\overline{\text{RTS0}}/\overline{\text{SS0}}$			
48		P13_7				OUTC2_7		D31
49		P13_6				OUTC2_1/ISCLK2		D30
50		P13_5				OUTC2_2/ISRXD2/ IEIN		D29
51		P13_4				OUTC2_0/ISTXD2/ IEOUT		D28
52		P5_7			$\overline{\text{CTS7}}/\overline{\text{RTS7}}$			$\overline{\text{RDY}}/\overline{\text{CS3}}$
53		P5_6			RXD7			ALE/$\overline{\text{CS2}}$
54		P5_5			CLK7			$\overline{\text{HOLD}}$
55		P5_4			TXD7			$\overline{\text{HLDA}}/\overline{\text{CS1}}$
56		P13_3				OUTC2_3		D27
57	VSS							
58		P13_2				OUTC2_6		D26
59	VCC							
60		P13_1				OUTC2_5		D25
61		P13_0				OUTC2_4		D24
62		P5_3						CLKOUT/ BCLK
63		P5_2						$\overline{\text{RD}}$
64		P5_1						$\overline{\text{WR1}}/\overline{\text{BC1}}$
65		P5_0						$\overline{\text{WR0}}/\overline{\text{WR}}$
66		P12_7						D23
67		P12_6						D22
68		P12_5						D21
69		P4_7			TXD6/SDA6/SRXD6			$\overline{\text{CS0}}$/A23
70		P4_6			RXD6/SCL6/STXD6			$\overline{\text{CS1}}$/A22
71		P4_5			CLK6			$\overline{\text{CS2}}$/A21
72		P4_4			$\overline{\text{CTS6}}/\overline{\text{RTS6}}/\overline{\text{SS6}}$			$\overline{\text{CS3}}$/A20
73		P4_3			TXD3/SDA3/SRXD3	OUTC2_0/ISTXD2/ IEOUT		A19
74	VCC							

Table 1.12 Pin Characteristics for the 100-pin Package (2/3)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Module Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
39		P5_5			CLK7			$\overline{\text{HOLD}}$
40		P5_4			TXD7			$\overline{\text{HLDA}}$/$\overline{\text{CS1}}$
41		P5_3						CLKOUT/ BCLK
42		P5_2						$\overline{\text{RD}}$
43		P5_1						$\overline{\text{WR1}}$/$\overline{\text{BC1}}$
44		P5_0						$\overline{\text{WR0}}$/$\overline{\text{WR}}$
45		P4_7			TXD6/SDA6/SRXD6			$\overline{\text{CS0}}$/A23
46		P4_6			RXD6/SCL6/STXD6			$\overline{\text{CS1}}$/A22
47		P4_5			CLK6			$\overline{\text{CS2}}$/A21
48		P4_4			$\overline{\text{CTS6}}$/$\overline{\text{RTS6}}$/$\overline{\text{SS6}}$			$\overline{\text{CS3}}$/A20
49		P4_3			TXD3/SDA3/SRXD3	OUTC2_0/ISTXD2/ IEOUT		A19
50		P4_2			RXD3/SCL3/STXD3	ISRXD2/IEIN		A18
51		P4_1			CLK3			A17
52		P4_0			$\overline{\text{CTS3}}$/$\overline{\text{RTS3}}$/$\overline{\text{SS3}}$			A16
53		P3_7		TA4IN/$\overline{\text{U}}$				A15(/D15)
54		P3_6		TA4OUT/U				A14(/D14)
55		P3_5		TA2IN/$\overline{\text{W}}$				A13(/D13)
56		P3_4		TA2OUT/W				A12(/D12)
57		P3_3		TA1IN/$\overline{\text{V}}$				A11(/D11)
58		P3_2		TA1OUT/V				A10(/D10)
59		P3_1		TA3OUT		UD0B/UD1B		A9(/D9)
60	VCC							
61		P3_0		TA0OUT		UD0A/UD1A		A8(/D8)
62	VSS							
63		P2_7					AN2_7	A7(/D7)
64		P2_6					AN2_6	A6(/D6)
65		P2_5					AN2_5	A5(/D5)
66		P2_4					AN2_4	A4(/D4)
67		P2_3					AN2_3	A3(/D3)
68		P2_2					AN2_2	A2(/D2)
69		P2_1					AN2_1	A1(/D1)
70		P2_0					AN2_0	A0(/D0)/ $\overline{\text{BC0}}$(/D0)
71		P1_7	$\overline{\text{INT5}}$			IIO0_7/IIO1_7		D15
72		P1_6	$\overline{\text{INT4}}$			IIO0_6/IIO1_6		D14
73		P1_5	$\overline{\text{INT3}}$			IIO0_5/IIO1_5		D13
74		P1_4				IIO0_4/IIO1_4		D12
75		P1_3				IIO0_3/IIO1_3		D11

Table 1.13 Pin Characteristics for the 100-pin Package (3/3)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Module Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
76		P1_2				IIO0_2/IIO1_2		D10
77		P1_1				IIO0_1/IIO1_1		D9
78		P1_0				IIO0_0/IIO1_0		D8
79		P0_7					AN0_7	D7
80		P0_6					AN0_6	D6
81		P0_5					AN0_5	D5
82		P0_4					AN0_4	D4
83		P0_3					AN0_3	D3
84		P0_2					AN0_2	D2
85		P0_1					AN0_1	D1
86		P0_0					AN0_0	D0
87		P10_7	$\overline{KI3}$				AN_7	
88		P10_6	$\overline{KI2}$				AN_6	
89		P10_5	$\overline{KI1}$				AN_5	
90		P10_4	$\overline{KI0}$				AN_4	
91		P10_3					AN_3	
92		P10_2					AN_2	
93		P10_1					AN_1	
94	AVSS							
95		P10_0					AN_0	
96	VREF							
97	AVCC							
98		P9_7			RXD4/SCL4/STXD4		$\overline{ADTRG}$	
99		P9_6			TXD4/SDA4/SRXD4		ANEX1	
100		P9_5			CLK4		ANEX0	

Table 1.15 Pin Definitions and Functions (2/4)

Function	Symbol	I/O	Description
Bus control pins	$\overline{BC0}$/D0, $\overline{BC2}$/D1 (1)	I/O	Output of byte control ($\overline{BC0}$ and $\overline{BC2}$) and input/output of data (D0 and D1) by time-division while accessing an external memory space with multiplexed bus
	$\overline{CS0}$ to $\overline{CS3}$	O	Chip select output
	$\overline{WR0}$/$\overline{WR1}$/$\overline{WR2}$/$\overline{WR3}$, $\overline{WR}$/$\overline{BC0}$/$\overline{BC1}$/$\overline{BC2}$/$\overline{BC3}$, $\overline{RD}$ (1)	O	Output of write, byte control, and read signals. Either $\overline{WRx}$ or $\overline{WR}$ and $\overline{BCx}$ can be selected by a program. Data is read when $\overline{RD}$ is low. • When $\overline{WR0}$, $\overline{WR1}$, $\overline{WR2}$, $\overline{WR3}$, and $\overline{RD}$ are selected, data is written to the following address: 4n+0, when $\overline{WR0}$ is low 4n+1, when $\overline{WR1}$ is low 4n+2, when $\overline{WR2}$ is low 4n+3, when $\overline{WR3}$ is low on 32-bit external data bus or an even address, when $\overline{WR0}$ is low an odd address, when $\overline{WR1}$ is low on 16-bit external data bus • When $\overline{WR}$, $\overline{BC0}$, $\overline{BC1}$, $\overline{BC2}$, $\overline{BC3}$, and $\overline{RD}$ are selected, data is written, when $\overline{WR}$ is low and the following address is accessed: 4n+0, when $\overline{BC0}$ is low 4n+1, when $\overline{BC1}$ is low 4n+2, when $\overline{BC2}$ is low 4n+3, when $\overline{BC3}$ is low on 32-bit external data bus or an even address, when $\overline{BC0}$ is low an odd address, when $\overline{BC1}$ is low on 16-bit external data bus
	ALE	O	Latch enable signal in multiplexed bus format
	$\overline{HOLD}$	I	The MCU is in a hold state while this pin is held low
	$\overline{HLDA}$	O	This pin is driven low while the MCU is held in a hold state
	$\overline{RDY}$	I	Bus cycle is extended by the CPU if this pin is low on the falling edge of BCLK

Note:
1. Pins $\overline{BC2}$/D1, $\overline{WR2}$, $\overline{WR3}$, $\overline{BC2}$, and $\overline{BC3}$ are available in the 144-pin package only.

2.1.8.5 Register Bank Select Flag (B flag)

This flag selects a register bank. It indicates 0 when register bank 0 is selected, and 1 when register bank 1 is selected.

2.1.8.6 Overflow Flag (O flag)

This flag becomes 1 when the result of an operation overflows; otherwise it is 0.

2.1.8.7 Interrupt Enable Flag (I flag)

This flag enables maskable interrupts. To disable maskable interrupts, set this flag to 0. To enable them, set this flag to 1. When an interrupt is accepted, the flag becomes 0.

2.1.8.8 Stack Pointer Select Flag (U flag)

To select the interrupt stack pointer (ISP), set this flag to 0. To select the user stack pointer (USP), set this flag to 1.
It becomes 0 when a hardware interrupt is accepted or when an INT instruction designated by a software interrupt number from 0 to 127 is executed.

2.1.8.9 Floating-point Underflow Flag (FU flag)

This flag becomes 1 when an underflow occurs in a floating-point operation; otherwise it is 0. It also becomes 1 when the operand contains invalid numbers (subnormal numbers).

2.1.8.10 Floating-point Overflow Flag (FO flag)

This flag becomes 1 when an overflow occurs in a floating-point operation; otherwise it is 0. It also becomes 1 when the operand contains invalid numbers (subnormal numbers).

2.1.8.11 Processor Interrupt Priority Level (IPL)

The processor interrupt priority level (IPL), consisting of 3 bits, selects a processor interrupt priority level from level 0 to 7. An interrupt is enabled when the interrupt request level is higher than the selected IPL.
When the processor interrupt priority level (IPL) is set to 111b (level 7), all interrupts are disabled.

2.1.8.12 Fixed-point Radix Point Designation Bit (DP bit)

This bit designates the radix point. It also specifies which portion of the fixed-point multiplication result to extract. It is used for the MULX instruction.

2.1.8.13 Floating-point Rounding Mode (RND)

The 2-bit floating-point rounding mode selects a rounding mode for floating-point calculation results.

2.1.8.14 Reserved

Only set this bit to 0. The read value is undefined.

Table 4.9 SFR List (9)

Address	Register	Symbol	Reset Value
0001A0h	Group 0 Base Timer Register	G0BT	XXXXh
0001A1h			
0001A2h	Group 0 Base Timer Control Register 0	G0BCR0	0000 0000b
0001A3h	Group 0 Base Timer Control Register 1	G0BCR1	0000 0000b
0001A4h	Group 0 Time Measurement Prescaler Register 6	G0TPR6	00h
0001A5h	Group 0 Time Measurement Prescaler Register 7	G0TPR7	00h
0001A6h	Group 0 Function Enable Register	G0FE	00h
0001A7h	Group 0 Function Select Register	G0FS	00h
0001A8h			
0001A9h			
0001AAh			
0001ABh			
0001ACh			
0001ADh			
0001AEh			
0001AFh			
0001B0h			
0001B1h			
0001B2h			
0001B3h			
0001B4h			
0001B5h			
0001B6h			
0001B7h			
0001B8h			
0001B9h			
0001BAh			
0001BBh			
0001BCh			
0001BDh			
0001BEh			
0001BFh			
0001C0h			
0001C1h			
0001C2h			
0001C3h			
0001C4h	UART5 Special Mode Register 4	U5SMR4	00h
0001C5h	UART5 Special Mode Register 3	U5SMR3	00h
0001C6h	UART5 Special Mode Register 2	U5SMR2	00h
0001C7h	UART5 Special Mode Register	U5SMR	00h
0001C8h	UART5 Transmit/Receive Mode Register	U5MR	00h
0001C9h	UART5 Bit Rate Register	U5BRG	XXh
0001CAh	UART5 Transmit Buffer Register	U5TB	XXXXh
0001CBh			
0001CCh	UART5 Transmit/Receive Control Register 0	U5C0	0000 1000b
0001CDh	UART5 Transmit/Receive Control Register 1	U5C1	0000 0010b
0001CEh	UART5 Receive Buffer Register	U5RB	XXXXh
0001CFh			

X: Undefined
Blanks are reserved. No access is allowed.

Table 4.11 SFR List (11)

Address	Register	Symbol	Reset Value
000200h to 0002BFh			
0002C0h	X0 Register/Y0 Register	X0R/Y0R	XXXXh
0002C1h			
0002C2h	X1 Register/Y1 Register	X1R/Y1R	XXXXh
0002C3h			
0002C4h	X2 Register/Y2 Register	X2R/Y2R	XXXXh
0002C5h			
0002C6h	X3 Register/Y3 Register	X3R/Y3R	XXXXh
0002C7h			
0002C8h	X4 Register/Y4 Register	X4R/Y4R	XXXXh
0002C9h			
0002CAh	X5 Register/Y5 Register	X5R/Y5R	XXXXh
0002CBh			
0002CCh	X6 Register/Y6 Register	X6R/Y6R	XXXXh
0002CDh			
0002CEh	X7 Register/Y7 Register	X7R/Y7R	XXXXh
0002CFh			
0002D0h	X8 Register/Y8 Register	X8R/Y8R	XXXXh
0002D1h			
0002D2h	X9 Register/Y9 Register	X9R/Y9R	XXXXh
0002D3h			
0002D4h	X10 Register/Y10 Register	X10R/Y10R	XXXXh
0002D5h			
0002D6h	X11 Register/Y11 Register	X11R/Y11R	XXXXh
0002D7h			
0002D8h	X12 Register/Y12 Register	X12R/Y12R	XXXXh
0002D9h			
0002DAh	X13 Register/Y13 Register	X13R/Y13R	XXXXh
0002DBh			
0002DCh	X14 Register/Y14 Register	X14R/Y14R	XXXXh
0002DDh			
0002DEh	X15 Register/Y15 Register	X15R/Y15R	XXXXh
0002DFh			
0002E0h	X-Y Control Register	XYC	XXXX XX00b
0002E1h			
0002E2h			
0002E3h			
0002E4h	UART1 Special Mode Register 4	U1SMR4	00h
0002E5h	UART1 Special Mode Register 3	U1SMR3	00h
0002E6h	UART1 Special Mode Register 2	U1SMR2	00h
0002E7h	UART1 Special Mode Register	U1SMR	00h
0002E8h	UART1 Transmit/Receive Mode Register	U1MR	00h
0002E9h	UART1 Bit Rate Register	U1BRG	XXh
0002EAh	UART1 Transmit Buffer Register	U1TB	XXXXh
0002EBh			
0002ECh	UART1 Transmit/Receive Control Register 0	U1C0	0000 1000b
0002EDh	UART1 Transmit/Receive Control Register 1	U1C1	0000 0010b
0002EEh	UART1 Receive Buffer Register	U1RB	XXXXh
0002EFh			

X: Undefined
Blanks are reserved. No access is allowed.

Table 4.21 SFR List (21)

Address	Register	Symbol	Reset Value
0400C0h	Port P4_0 Function Select Register	P4_0S	X0XX X000b
0400C1h	Port P5_0 Function Select Register	P5_0S	XXXX X000b
0400C2h	Port P4_1 Function Select Register	P4_1S	X0XX X000b
0400C3h	Port P5_1 Function Select Register	P5_1S	XXXX X000b
0400C4h	Port P4_2 Function Select Register	P4_2S	X0XX X000b
0400C5h	Port P5_2 Function Select Register	P5_2S	XXXX X000b
0400C6h	Port P4_3 Function Select Register	P4_3S	X0XX X000b
0400C7h	Port P5_3 Function Select Register	P5_3S	XXXX X000b
0400C8h	Port P4_4 Function Select Register	P4_4S	X0XX X000b
0400C9h	Port P5_4 Function Select Register	P5_4S	X0XX X000b
0400CAh	Port P4_5 Function Select Register	P4_5S	X0XX X000b
0400CBh	Port P5_5 Function Select Register	P5_5S	X0XX X000b
0400CCh	Port P4_6 Function Select Register	P4_6S	X0XX X000b
0400CDh	Port P5_6 Function Select Register	P5_6S	X0XX X000b
0400CEh	Port P4_7 Function Select Register	P4_7S	X0XX X000b
0400CFh	Port P5_7 Function Select Register	P5_7S	X0XX X000b
0400D0h	Port P6_0 Function Select Register	P6_0S	X0XX X000b
0400D1h	Port P7_0 Function Select Register	P7_0S	X0XX X000b
0400D2h	Port P6_1 Function Select Register	P6_1S	X0XX X000b
0400D3h	Port P7_1 Function Select Register	P7_1S	X0XX X000b
0400D4h	Port P6_2 Function Select Register	P6_2S	X0XX X000b
0400D5h	Port P7_2 Function Select Register	P7_2S	X0XX X000b
0400D6h	Port P6_3 Function Select Register	P6_3S	X0XX X000b
0400D7h	Port P7_3 Function Select Register	P7_3S	X0XX X000b
0400D8h	Port P6_4 Function Select Register	P6_4S	X0XX X000b
0400D9h	Port P7_4 Function Select Register	P7_4S	X0XX X000b
0400DAh	Port P6_5 Function Select Register	P6_5S	X0XX X000b
0400DBh	Port P7_5 Function Select Register	P7_5S	X0XX X000b
0400DCh	Port P6_6 Function Select Register	P6_6S	X0XX X000b
0400DDh	Port P7_6 Function Select Register	P7_6S	X0XX X000b
0400DEh	Port P6_7 Function Select Register	P6_7S	X0XX X000b
0400DFh	Port P7_7 Function Select Register	P7_7S	X0XX X000b
0400E0h	Port P8_0 Function Select Register	P8_0S	X0XX X000b
0400E1h	Port P9_0 Function Select Register	P9_0S	X0XX X000b
0400E2h	Port P8_1 Function Select Register	P8_1S	X0XX X000b
0400E3h	Port P9_1 Function Select Register	P9_1S	X0XX X000b
0400E4h	Port P8_2 Function Select Register	P8_2S	X0XX X000b
0400E5h	Port P9_2 Function Select Register	P9_2S	X0XX X000b
0400E6h	Port P8_3 Function Select Register	P8_3S	X0XX X000b
0400E7h	Port P9_3 Function Select Register	P9_3S	00XX X000b
0400E8h	Port P8_4 Function Select Register	P8_4S	XXXX X000b
0400E9h	Port P9_4 Function Select Register	P9_4S	00XX X000b
0400EAh			
0400EBh	Port P9_5 Function Select Register	P9_5S	00XX X000b
0400ECh	Port P8_6 Function Select Register	P8_6S	XXXX X000b
0400EDh	Port P9_6 Function Select Register	P9_6S	00XX X000b
0400EEh	Port P8_7 Function Select Register	P8_7S	XXXX X000b
0400EFh	Port P9_7 Function Select Register	P9_7S	X0XX X000b

X: Undefined
Blanks are reserved. No access is allowed.

Table 4.29 SFR List (29)

Address	Register	Symbol	Reset Value
047C90h	CAN0 Mailbox 9: Message Identifier	C0MB9	XXXX XXXXh
047C91h			
047C92h			
047C93h			
047C94h			
047C95h	CAN0 Mailbox 9: Data Length		XXh
047C96h	CAN0 Mailbox 9: Data Field		XXXX XXXX
047C97h			XXXX XXXXh
047C98h			
047C99h			
047C9Ah			
047C9Bh			
047C9Ch			
047C9Dh			
047C9Eh	CAN0 Mailbox 9: Time Stamp		XXXXh
047C9Fh			
047CA0h	CAN0 Mailbox 10: Message Identifier	C0MB10	XXXX XXXXh
047CA1h			
047CA2h			
047CA3h			
047CA4h			
047CA5h	CAN0 Mailbox 10: Data Length		XXh
047CA6h	CAN0 Mailbox 10: Data Field		XXXX XXXX
047CA7h			XXXX XXXXh
047CA8h			
047CA9h			
047CAAh			
047CABh			
047CACh			
047CADh			
047CAEh	CAN0 Mailbox 10: Time Stamp		XXXXh
047CAFh			
047CB0h	CAN0 Mailbox 11: Message Identifier	C0MB11	XXXX XXXXh
047CB1h			
047CB2h			
047CB3h			
047CB4h			
047CB5h	CAN0 Mailbox 11: Data Length		XXh
047CB6h	CAN0 Mailbox 11: Data Field		XXXX XXXX
047CB7h			XXXX XXXXh
047CB8h			
047CB9h			
047CBAh			
047CBBh			
047CBCh			
047CBDh			
047CBEh	CAN0 Mailbox 11: Time Stamp		XXXXh
047CBFh			

X: Undefined
Blanks are reserved. No access is allowed.

Table 4.30 SFR List (30)

Address	Register	Symbol	Reset Value
047CC0h	CAN0 Mailbox 12: Message Identifier	C0MB12	XXXX XXXXh
047CC1h			
047CC2h			
047CC3h			
047CC4h			
047CC5h	CAN0 Mailbox 12: Data Length		XXh
047CC6h	CAN0 Mailbox 12: Data Field		XXXX XXXX
047CC7h			XXXX XXXXh
047CC8h			
047CC9h			
047CCAh			
047CCBh			
047CCCh			
047CCDh			
047CCEh	CAN0 Mailbox 12: Time Stamp		XXXXh
047CCFh			
047CD0h	CAN0 Mailbox 13: Message Identifier	C0MB13	XXXX XXXXh
047CD1h			
047CD2h			
047CD3h			
047CD4h			
047CD5h	CAN0 Mailbox 13: Data Length		XXh
047CD6h	CAN0 Mailbox 13: Data Field		XXXX XXXX
047CD7h			XXXX XXXXh
047CD8h			
047CD9h			
047CDAh			
047CDBh			
047CDCh			
047CDDh			
047CDEh	CAN0 Mailbox 13: Time Stamp		XXXXh
047CDFh			
047CE0h	CAN0 Mailbox 14: Message Identifier	C0MB14	XXXX XXXXh
047CE1h			
047CE2h			
047CE3h			
047CE4h			
047CE5h	CAN0 Mailbox 14: Data Length		XXh
047CE6h	CAN0 Mailbox 14: Data Field		XXXX XXXX
047CE7h			XXXX XXXXh
047CE8h			
047CE9h			
047CEAh			
047CEBh			
047CECh			
047CEDh			
047CEEh	CAN0 Mailbox 14: Time Stamp		XXXXh
047CEFh			

X: Undefined
Blanks are reserved. No access is allowed.

Table 5.4 Operating Conditions (3/5)
(V_{CC} = 3.0 to 5.5 V, V_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted) (1)

Symbol	Characteristic		Value			Unit
			Min.	Typ.	Max.	
$I_{OH(peak)}$	High level peak output current (2)	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 (3)			-10.0	mA
$I_{OH(avg)}$	High level average output current (4)	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 (3)			-5.0	mA
$I_{OL(peak)}$	Low level peak output current (2)	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 (3)			10.0	mA
$I_{OL(avg)}$	Low level average output current (4)	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 (3)			5.0	mA

Notes:
1. The device is operationally guaranteed under these operating conditions.
2. The following conditions should be satisfied:
   - The sum of $I_{OL(peak)}$ of ports P0, P1, P2, P8_6, P8_7, P9, P10, P11, P14, and P15 is 80 mA or less.
   - The sum of $I_{OL(peak)}$ of ports P3, P4, P5, P6, P7, P8_0 to P8_4, P12, and P13 is 80 mA or less.
   - The sum of $I_{OH(peak)}$ of ports P0, P1, P2, and P11 is -40 mA or less.
   - The sum of $I_{OH(peak)}$ of ports P8_6, P8_7, P9, P10, P14, and P15 is -40 mA or less.
   - The sum of $I_{OH(peak)}$ of ports P3, P4, P5, P12, and P13 is -40 mA or less.
   - The sum of $I_{OH(peak)}$ of ports P6, P7, and P8_0 to P8_4 is -40 mA or less.
3. Ports P9_0, P9_2, and P11 to P15 are available in the 144-pin package only. Port P9_1 is designated as input pin in the 100-pin package.
4. Average value within 100 ms.

Table 5.6 Operating Conditions (5/5)
(V_{CC} = 3.0 to 5.5 V, V_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted) (1)

Symbol	Characteristic		Value			Unit
			Min.	Typ.	Max.	
$V_{r(VCC)}$	Allowable ripple voltage	V_{CC} = 5.0 V			0.5	Vp-p
		V_{CC} = 3.0 V			0.3	Vp-p
$dV_{r(VCC)}/dt$	Ripple voltage gradient	V_{CC} = 5.0 V			±0.3	V/ms
		V_{CC} = 3.0 V			±0.3	V/ms
$f_{r(VCC)}$	Allowable ripple frequency				10	kHz

Note:
1. The device is operationally guaranteed under these operating conditions.

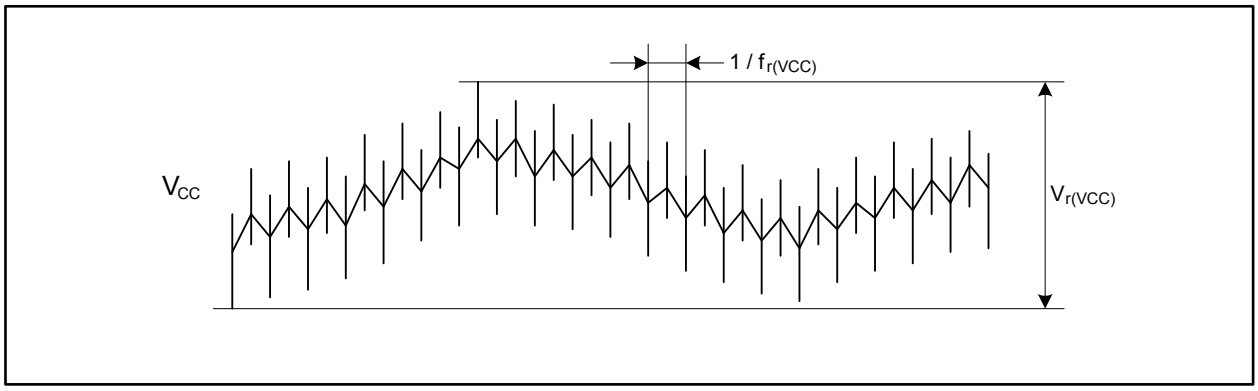


Figure 5.2 Ripple Waveform

V_{CC} = 5 V

Switching Characteristics (V_{CC} = 4.2 to 5.5 V, V_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted)

Table 5.37 Serial Interface

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{d(C-Q)}$	TXDi output delay time	Refer to Figure 5.6		80	ns
$t_{h(C-Q)}$	TXDi output hold time		0		ns

Table 5.38 Intelligent I/O

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{d(ISCLK2-TXD)}$	ISTXD2 output delay time	Refer to Figure 5.6		180	ns
$t_{h(ISCLK2-RXD)}$	ISTXD2 output hold time		0		ns

Table 5.39 Multi-master I²C-bus Interface (standard-mode)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{f(SCL)}$	MSCL output fall time	Refer to Figure 5.6	2		ns
$t_{f(SDA)}$	MSDA output fall time		2		ns
$t_{d(SDA-SCL)S}$	MSCL output delay time after START condition/repeated START condition		$20 \times t_{c(\phi IIC)} - 120$	$52 \times t_{c(\phi IIC)} - 40$	ns
$t_{d(SCL-SDA)P}$	Repeated START condition/STOP condition output delay time after MSCL becomes high		$20 \times t_{c(\phi IIC)} + 40$	$52 \times t_{c(\phi IIC)} + 120$	ns
$t_{d(SCL-SDA)}$	MSDA output delay time		$2 \times t_{c(\phi IIC)} + 40$	$3 \times t_{c(\phi IIC)} + 120$	ns

Table 5.40 Multi-master I²C-bus Interface (fast-mode)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{f(SCL)}$	MSCL output fall time	Refer to Figure 5.6	2 (1)		ns
$t_{f(SDA)}$	MSDA output fall time		2 (1)		ns
$t_{d(SDA-SCL)S}$	MSCL output delay time after START condition/repeated START condition		$10 \times t_{c(\phi IIC)} - 120$	$26 \times t_{c(\phi IIC)} - 40$	ns
$t_{d(SCL-SDA)P}$	Repeated START condition/STOP condition output delay time after MSCL becomes high		$10 \times t_{c(\phi IIC)} + 40$	$26 \times t_{c(\phi IIC)} + 120$	ns
$t_{d(SCL-SDA)}$	MSDA output delay time		$2 \times t_{c(\phi IIC)} + 40$	$3 \times t_{c(\phi IIC)} + 120$	ns

Note:

1. External circuits are required to satisfy the I²C-bus specification.

V_{CC} = 3.3 V

Switching Characteristics (V_{CC} = 3.0 to 3.6 V, V_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted)

Table 5.61 External Bus Timing (separate bus)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{su(S-R)}$	Chip-select setup time before read	Refer to Figure 5.6	(1)		ns
$t_{h(R-S)}$	Chip-select hold time after read		$t_{c(Base)}$ - 15		ns
$t_{su(A-R)}$	Address setup time before read		(1)		ns
$t_{h(R-A)}$	Address hold time after read		$t_{c(Base)}$ - 15		ns
$t_{w(R)}$	Read pulse width		(1)		ns
$t_{su(S-W)}$	Chip-select setup time before write		(1)		ns
$t_{h(W-S)}$	Chip-select hold time after write		1.5 × $t_{c(Base)}$ - 15		ns
$t_{su(A-W)}$	Address setup time before write		(1)		ns
$t_{h(W-A)}$	Address hold time after write		1.5 × $t_{c(Base)}$ - 15		ns
$t_{w(W)}$	Write pulse width		(1)		ns
$t_{su(D-W)}$	Data setup time before write		(1)		ns
$t_{h(W-D)}$	Data hold time after write		0		ns

Note:

1. The value is calculated using the formulas below based on the base clock cycles ($t_{c(Base)}$) and respective cycles of Tsu(A-R), Tw(R), Tsu(A-W), and Tw(W) set by registers EBC0 to EBC3. If the calculation results in a negative value, modify the value to be set. For details on how to set values, refer to the User's manual.

   $t_{su(S-R)} = t_{su(A-R)}$ = Tsu(A-R) × $t_{c(Base)}$ - 15 [ns]

   $t_{w(R)}$ = Tw(R) × $t_{c(Base)}$ - 10 [ns]

   $t_{su(S-W)} = t_{su(A-W)}$ = Tsu(A-W) × $t_{c(Base)}$ - 15 [ns]

   $t_{w(W)} = t_{su(D-W)}$ = Tw(W) × $t_{c(Base)}$ - 10 [ns]

V_{CC} = 3.3 V

Switching Characteristics (V_{CC} = 3.0 to 3.6 V, V_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted)

Table 5.63 Serial Interface

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{d(C-Q)}$	TXDi output delay time	Refer to Figure 5.6		80	ns
$t_{h(C-Q)}$	TXDi output hold time		0		ns

Table 5.64 Intelligent I/O

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{d(ISCLK2-TXD)}$	ISTXD2 output delay time	Refer to Figure 5.6		180	ns
$t_{h(ISCLK2-RXD)}$	ISTXD2 output hold time		0		ns

Table 5.65 Multi-master I²C-bus Interface (Standard-mode)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{f(SCL)}$	MSCL output fall time	Refer to Figure 5.6	2		ns
$t_{f(SDA)}$	MSDA output fall time		2		ns
$t_{d(SDA-SCL)S}$	MSCL output delay time after START condition/repeated START condition		$20 \times t_{c(\phi IIC)} - 120$	$52 \times t_{c(\phi IIC)} - 40$	ns
$t_{d(SCL-SDA)P}$	Repeated START condition/STOP condition output delay time after MSCL becomes high		$20 \times t_{c(\phi IIC)} + 40$	$52 \times t_{c(\phi IIC)} + 120$	ns
$t_{d(SCL-SDA)}$	MSDA output delay time		$2 \times t_{c(\phi IIC)} + 40$	$3 \times t_{c(\phi IIC)} + 120$	ns

Table 5.66 Multi-master I²C-bus Interface (Fast-mode)

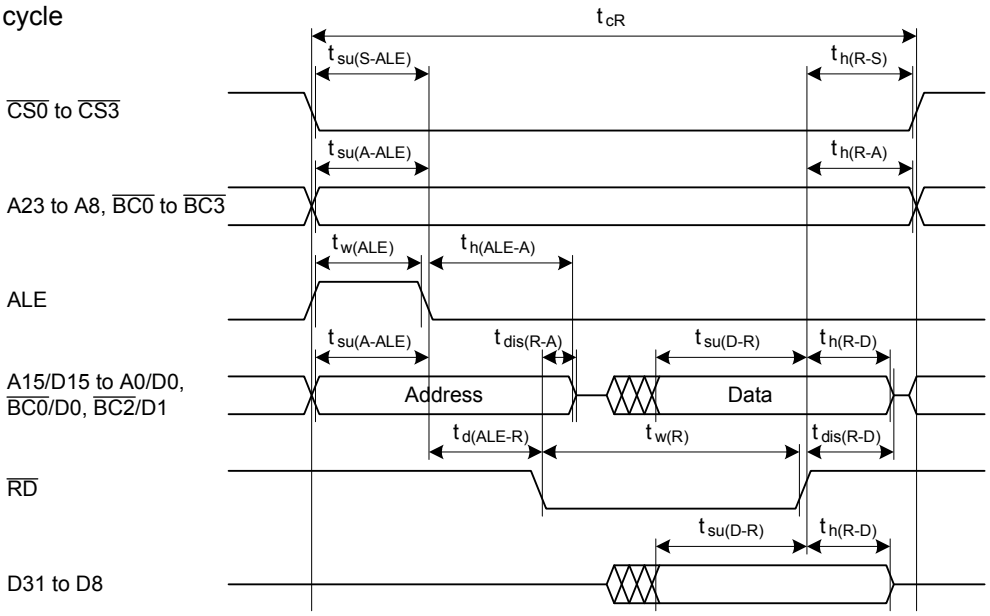
Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{f(SCL)}$	MSCL output fall time	Refer to Figure 5.6	2 (1)		ns
$t_{f(SDA)}$	MSDA output fall time		2 (1)		ns
$t_{d(SDA-SCL)S}$	MSCL output delay time after START condition/repeated START condition		$10 \times t_{c(\phi IIC)} - 120$	$26 \times t_{c(\phi IIC)} - 40$	ns
$t_{d(SCL-SDA)P}$	Repeated START condition/STOP condition output delay time after MSCL becomes high		$10 \times t_{c(\phi IIC)} + 40$	$26 \times t_{c(\phi IIC)} + 120$	ns
$t_{d(SCL-SDA)}$	MSDA output delay time		$2 \times t_{c(\phi IIC)} + 40$	$3 \times t_{c(\phi IIC)} + 120$	ns

Note:

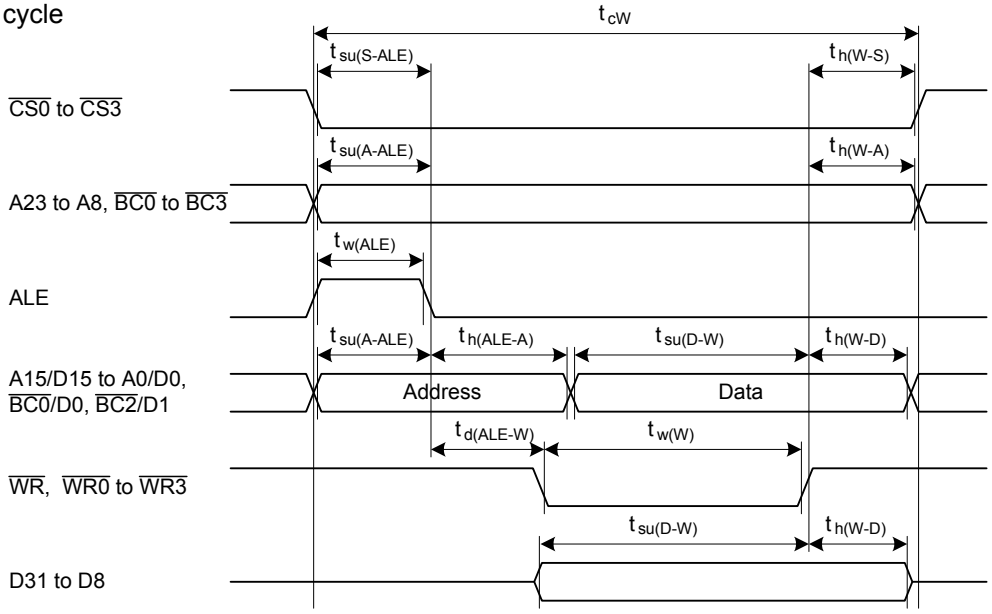
1. External circuits are required to satisfy the I²C-bus specification.

External bus timing (multiplexed bus)

Read cycle



Write cycle



Measurement conditions

Item		V_{CC} = 4.2 to 5.5 V	V_{CC} = 3.0 to 3.6 V
Criterion for input voltage	V_{IH}	2.5 V	1.5 V
	V_{IL}	0.8 V	0.5 V
Criterion for output voltage	V_{OH}	2.0 V	2.4 V
	V_{OL}	0.8 V	0.5 V

Figure 5.9 External Bus Timing for Multiplexed Bus

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

   Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

   - The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   - The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

     In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

     In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   - The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   - When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

   Before changing from one product to another, i.e. to one with a different part number, confirm

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